5/10> 4-1-03



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Charles W.C. Lin

Title:

SUPPORT CIRCUIT WITH A TAPERED THROUGH-HOLE

FOR A SEMICONDUCTOR CHIP ASSEMBLY

Serial No.:

10/002,732

Filed:

November 15, 2001

Examiner:

Unknown

Group Art Unit:

Unknown

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ASSISTANT COMMISSIONER FOR PATENTS

Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Pursuant to Applicant's duty of disclosure under 37 C.F.R. § 1.56 and §§ 1.97-1.98, Applicant hereby provides a copy of the documents identified on the enclosed Form PTO-1449.

The filing of this Information Disclosure Statement shall not be construed as a representation that a search has been made, an admission that any of these documents, alone or in any combination, is considered to be material to patentability, an admission that any of these documents is prior art as to the above-identified application, or an admission against interest in any manner.

This Information Disclosure Statement is filed before the mailing date of a first Office Action on the merits. Accordingly, no fee is due. 37 C.F.R. § 1.97(b)(3).

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I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on December 17, 2001.

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12,17,61 Date of Signature

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Respectfully submitted,

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